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# Focused-Helium-Ion-Beam Blow Forming of Nanostructures: Radiation Damage and Nanofabrication

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## Abstract

Targeted irradiation of nanostructures by a finely focused ion beam provides routes to improved control of material modification and understanding of the physics of interactions between ion beams and nanomaterials. Here, we studied radiation damage in crystalline diamond and silicon nanostructures using a focused helium ion beam, with the former exhibiting extremely long-range ion propagation and large plastic deformation in a process visibly analogous to blow forming. We report the dependence of damage morphology on material, geometry, and irradiation conditions (ion dose, ion energy, ion species, and location). We anticipate that our method and findings will not only improve the understanding of radiation damage in isolated nanostructures, but will also support the design of new engineering materials and devices for current and future applications in nanotechnology.

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3 **Keywords:** Ion range, helium nanocavitation, focused helium ion beam, diamond,  
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5 nanofabrication, plastic deformation  
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## 10 **Introduction**

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12 Ion irradiation has been used extensively to tune the mechanical,<sup>1-3</sup> optical,<sup>4-6</sup> electrical,<sup>4,6,7</sup> and  
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14 chemical<sup>8,9</sup> properties of materials, as well as for nanofabrication.<sup>6,8,10-12</sup> Understanding the  
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16 response of materials to ion irradiation is especially important for the design of engineering  
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18 materials, such as radiation-tolerant materials for nuclear reactors,<sup>3,13-15</sup> for ion implantation in  
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20 semiconductors and for nanofabrication. In nanostructures, finely focused ion beams may play a  
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22 critical role in locally modifying materials. For example, focused gallium ion beams (FGIB) have  
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24 been used extensively for local modification of materials such as surface hardening,<sup>2</sup> wire  
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26 straightening,<sup>16</sup> and nanowire growth.<sup>17</sup> Helium ion microscopy (HIM), facilitated by the  
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28 development of gas field ion sources and sub-nanometer-diameter focused helium ion beams  
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30 (FHIB), has opened up new avenues for imaging<sup>18</sup> and single-nanometer scale fabrication.<sup>19</sup>  
31  
32 Potential impacts of HIM on nanoscience include nanometrology for critical dimension  
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34 measurement,<sup>20</sup> biological imaging,<sup>21</sup> and nanofabrication for plasmonic antennas,<sup>22</sup> nanopores,<sup>23</sup>  
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36 transmission electron microscopy (TEM) lamellae,<sup>24</sup> photomask repair,<sup>25</sup> and circuit editing.<sup>26</sup>  
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38 Local modification of materials and defect creation *via* FHIB at the nanoscale has also been applied  
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40 to quantum optics<sup>27</sup> and circuits.<sup>28,29</sup>  
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47 Understanding He<sup>+</sup> scattering in materials is critical to the use of FHIB to control material  
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49 properties. In general, the distribution of FHIB-induced damage in materials depends on (1) the  
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51 scattering ranges of helium in the material, (2) the sputtering yield and (3) helium solubility in the  
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53 material. (1) Radial scattering and ion ranges of He<sup>+</sup> in materials are approximately twelve times  
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3 larger than that of Ga<sup>+</sup> with equivalent kinetic energy since the stopping power of He<sup>+</sup> is about  
4 twelve times lower than that of Ga<sup>+</sup>. (2) The sputtering yield of He<sup>+</sup> is two orders of magnitude  
5 lower than that of Ga<sup>+</sup> for the materials studied in this work (carbon and silicon). This difference  
6 arises because He<sup>+</sup> loses energy primarily *via* electronic interactions with fewer atomic  
7 displacements than observed for Ga<sup>+</sup>. Also, Ga<sup>+</sup>-induced damage can reach a steady-state  
8 condition, resulting in a constant Ga<sup>+</sup> implantation profile by continuous surface recession due to  
9 sputtering.<sup>30</sup> (3) Helium has primarily repulsive interactions with host material atoms due to its  
10 closed-shell electron configuration and thus a low equilibrium solubility in the host material.<sup>31</sup> As  
11 a result, if kinetics allow, implanted He atoms can precipitate as He gas bubbles, which grow to  
12 dimensions equivalent to that of the He<sup>+</sup>-exposed region. This bubble formation can lead to  
13 significant morphological changes such as surface swelling at ion doses of over 10<sup>17</sup> ions/cm<sup>2</sup>.<sup>32,33</sup>  
14 If all three characteristics are considered, implanted He<sup>+</sup> may accumulate significantly within  
15 nanostructures, leading to gas bubble growth and “bloating” of targets without forming a steady-  
16 state radiation-damage profile. Simultaneously and unlike Ga<sup>+</sup>, He<sup>+</sup> can scatter/diffuse and escape  
17 from irradiated targets into the surrounding vacuum by a process which we refer to as He<sup>+</sup> leakage.  
18 Consequently, He<sup>+</sup> may display a range of scattering behaviors in nanostructures resulting in both  
19 internal and surface damage to nanostructured targets (see figure S1 in the supplementary  
20 information for example).

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45 Despite the physical understanding described above, details of the radiation effects due to  
46 FHIB have thus far only been investigated for a limited number of materials such as Si,<sup>32,34,35</sup> Cu,<sup>32</sup>  
47 Ni-Mo/Si,<sup>25</sup> TiO<sub>2</sub>,<sup>34</sup> and graphene,<sup>36</sup> even though numerous other materials of interest exist.  
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Diamond (crystalline carbon, hereafter referred to as c-C) is a particularly promising material in  
nanotechnology due to its extraordinary mechanical, optical, and thermal properties, and its

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3 biocompatibility<sup>37–39</sup> for micro- and nano-electromechanical systems.<sup>40,41</sup> It is also of interest for  
4 quantum optics/computing,<sup>42,43</sup> magnetic resonance imaging (MRI),<sup>44,45</sup> and as an electron-optical  
5 material in new microscopy techniques such as quantum electron microscopy.<sup>46</sup> Therefore, there  
6 is considerable interest in understanding how c-C can be probed and modified using localized,  
7 targeted ion irradiation, for example a FHIB has been used to generate defects at controlled  
8 locations in diamond, which can subsequently be converted to luminescent nitrogen-vacancy  
9 centers for use in nanoscale MRI.<sup>27,47</sup>

19 In this work, we study the interaction of a FHIB with c-C nanostructures compared to those  
20 produced in crystalline silicon (hereafter referred to as c-Si). A new experimental approach to  
21 observe ion-nanostructure interactions in three dimensions (3D) is described, by preparing  
22 electron-transparent samples using FGIB and then characterizing FHIB-induced modifications in  
23 those samples both internally and externally by transmission and scanning electron microscopy  
24 (TEM and SEM), respectively. We investigated ion-nanostructure interactions as a function of  
25 material composition, ion dose, crystal orientation, substrate thickness, and ion energy. We  
26 observed nanostructure-specific physical phenomena, including anomalously long ion-penetration  
27 lengths and internal-gas-pressure-induced plastic deformation. We explain these phenomena by  
28 comparing material dimensions and morphologies measured by electron microscopy to Monte  
29 Carlo simulations. We used both SRIM<sup>48</sup> for ion-range prediction and Irradiation of Materials in  
30 3D (IM3D)<sup>49</sup> to consider ion leakage effects in nanostructures. Furthermore, we have expanded  
31 our study to a new nanofabrication method for the production of 3D features through modification  
32 of existing micro- and nano-structures.

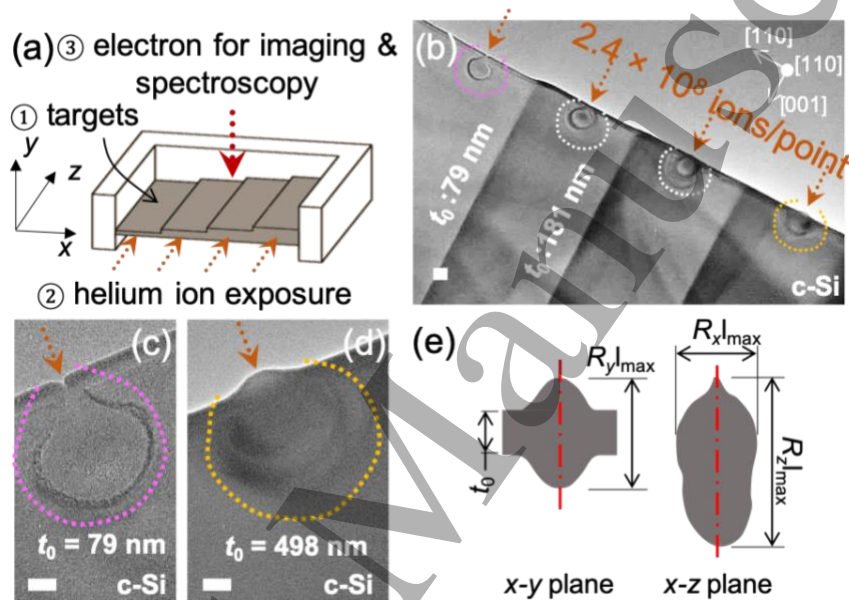
## 51 **Method**

Figure 1a outlines our experimental approach to investigate FHIB effects on nanostructures and describes the three-step experimental procedure graphically. First, we used FGIB milling to prepare monocrystalline nanostructures with different geometries and crystal orientations on a TEM grid. Second, we irradiated targeted regions of the nanostructures under various conditions with a FHIB. Finally, we use TEM and SEM to observe He<sup>+</sup>-induced changes to internal and external morphologies, respectively. This method has advantages in that it provides direct 3D observation of site- and nanostructure-specific radiation damage without any post-processing of the specimens after ion irradiation. Previously, a similar method has been used, but no site- and nanostructure-specific damage was presented.<sup>50</sup> Using this experimental method, c-C nanostructures were the primary focus, while nanostructures of c-Si were chosen for comparison as there have already been a number of investigations of the response to c-Si to FHIB irradiation in both bulk and thin membrane forms.<sup>32,51</sup> Throughout the text we use a number of variables to correlate material properties (geometry and composition) and ion exposure conditions to observed changes in the materials. We have summarized these variables in Table 1. The supplementary material describes materials used, experiments, and measurements in greater detail.

Table 1. Summary of variables used in this work and the variables that they represent.

Variable	Definition
$t_0$	membrane thickness
$D_0$	ion dose
$E_0$	kinetic energy of ion
$R_r$	radial range of ion-induced damage in a homogeneous material
$R_{x \max}, R_{y \max}, R_{z \max}$	maximum range of ion-induced damage along $x$ , $y$ and $z$ axes. In a homogeneous material, $R_{x \max} = R_{y \max} = 2 R_r$
$t_{d \max}, T_{d \max}$	$t_{d \max}$ represents the thickness of the deformed region <i>i.e.</i> $R_{y \max} - t_0$ , which has a saturation value of $T_{d \max}$

$P_{acc}, P_{acc}^{SRIM}, P_{acc}^{IM3D}$	probability of helium ion coming to rest inside the nanostructure ( $P_{acc}$ ) as calculated by SRIM ( $P_{acc}^{SRIM}$ ) or IM3D ( $P_{acc}^{IM3D}$ )
$P_{esc}$	probability of helium escaping from material <i>i.e.</i> $1 - P_{acc}$
$p_i, p_{i max}$	internal helium pressure within material ( $p_i$ ) and maximum internal pressure at which higher order deformation proceeds
$k$	deformation resistance factor

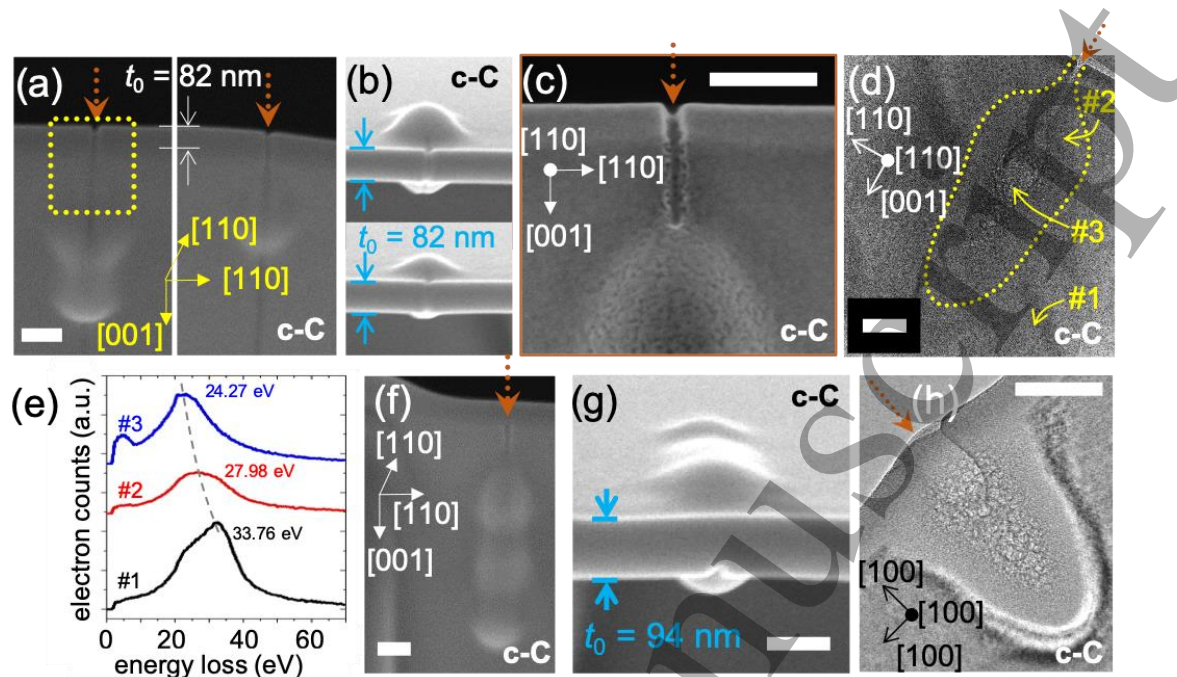


**Figure 1.** Experimental method and examples of ion-nanostructure interactions in silicon. (a) Schematic of experimental method and procedure. (1) Preparation of electron transparent targets with different geometries (grey color) by FGIB and lift-out technique. (2) Targeted irradiation of nanostructures. (3) Characterization by electron microscopy. (b) TEM image of c-Si membranes with different thicknesses irradiated with 35 keV He<sup>+</sup> as illustrated in (a). A point-exposure delivered  $2.4 \times 10^8$  ions/point to each membrane in the direction of the orange arrows. (c-d) Higher magnification TEM images when membrane thickness  $t_0 = 79$  nm and  $t_0 = 498$  nm in (b). The former shows removed volume and the latter shows swelled volume at the FHIB entry point as indicated by the orange arrows. (e) Measured parameters ( $R_{x,y,z|max}$ ) for He<sup>+</sup>-exposed membranes viewed normal to the x-y plane (SEM) and the x-z plane (TEM). White scale bars represent a length of 100 nm.

## Results and discussion



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3 In this work, we studied interactions between a FHIB and c-C and c-Si nanostructures as a function  
4 of various parameters, including ion-exposure method (single point or scanned), exposure location,  
5 ion dose ( $D_0$ ), ion energy ( $E_0$ ), nanostructure geometry, and ion species. Figure 1 provides an  
6 overview of our approach and a summary of the damage observed in silicon samples for  
7 comparison to diamond in subsequent figures. In figures 1b-d we consider the interactions of a  
8 FHIB with c-Si membranes that were fabricated with different thicknesses ( $t_0$ ). Comparing figures  
9 1c and 1d, we see significant surface swelling at the point where the FHIB enters the 498 nm thick  
10 membrane, which is absent from the 79-nm-thick membrane. This comparison implies that FHIB-  
11 induced damage depends on sample geometry as is also seen in the case of c-C and discussed later  
12 in figure 5. Figure 1e shows how we measured FHIB-induced damage in a thin membrane using  
13 electron microscopy. The maximum lateral range of damage along the  $x$ -axis, termed  $R_{x|max}$  and  
14 longitudinal range along the  $z$ -axis, termed  $R_{z|max}$  was measured in the  $x$ - $z$  plane, along with the  
15 maximum volume deformation along the  $y$ -axis in the  $x$ - $y$  plane,  $R_{y|max}$ . In a homogeneous medium,  
16  $R_{x|max}$  and  $R_{y|max}$  are expected to be equal and would both be estimated as twice the radial  
17 distribution range  $R_r$  (measured from the optical axis), due to the axial symmetry of  $He^+$  scattering  
18 in a bulk homogeneous solid. In our case, we must treat  $R_{x|max}$  and  $R_{y|max}$  differently, because  
19 damage is formed differently along the  $x$ - and  $y$ -axes. Thus,  $R_{x|max}$  was comparable to  $2R_r$  and  
20  $R_{y|max}$  was used to estimate the observed volume deformation. We use these measured values as  
21 well as others listed in table 1 to explain results related to FHIB-induced damage in this work.  
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**Figure 2.** Examples of ion-nanostructure interactions in diamond (c-C). (a-b) SEM images of 82-nm-thick c-C membranes exposed to 35 keV He<sup>+</sup>. A line-exposure along the y-axis delivered  $2.4 \times 10^8$  (left) and  $4.0 \times 10^7$  ions/line (right). Damage observed in (a) and (b) was viewed at angles of  $52^\circ$  and  $-10^\circ$ , respectively, and shows dose-dependent volume deformation. (c) Magnified SEM image of region in yellow box in (a) shows a sputtered volume and a roughened surface. (d) TEM image of left side of sample in (a) showing internal He<sup>+</sup>-induced damage within the region outlined by the dashed line. (e) EELS spectra showing the shift in energy of volume plasmon peaks, sampled from three points in (d). Peaks at 33.76 eV, 27.98 eV, and 24.28 eV in curves #1 to #3 resulted in calculated densities of 3.47 g/cm<sup>3</sup>, 2.38 g/cm<sup>3</sup>, and 1.79 g/cm<sup>3</sup>. (f-g) SEM images of 94-nm-thick c-C membranes exposed to 35 keV He<sup>+</sup> with a dose of  $2.4 \times 10^8$  ion/point and the same crystal orientation as in figures a-b. He<sup>+</sup> point-exposure was applied at the edge of the membrane on the x-y plane. Images show three volume deformations. (h) TEM image of 87 nm thick c-C membrane exposed to 10 keV He<sup>+</sup> with a dose of  $8.0 \times 10^7$  ion/point. Surface sputtering and gas bubble formation are observed. White scale bars represent a length of 100 nm.

Figure 2 summarizes the observed interactions between a FHIB and c-C membranes. Figures 2a-b show the surface of an 82-nm-thick c-C membrane after irradiation by a linear scan with a FHIB at two different doses and shows that more FHIB-induced damage occurred along the x- and z-directions when a higher dose was applied. The observed swelling orthogonal to the beam direction

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3 was not always seen in previous reports,<sup>35</sup> as it would have been destroyed during preparation of  
4 the TEM sample except in the case of the methods used in references 3 and 10. Volumetric  
5 deformation seen in figures 2a-b is indicative of dose-dependent FHIB-induced damage.  
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7 Furthermore, comparison of these results with those for c-Si shown in figures 1b-d highlights the  
8 additional material dependence. Figure 2c is a magnified image of the yellow boxed region in  
9 figure 2a and shows that our method enables observation of changes in surface morphologies due  
10 to nanoscale sputtering. Figure 2d displays a TEM image of the damaged region within the  
11 nanostructure presented at the left side in figure 2a. This figure shows the internal structure of the  
12 region irradiated by the FHIB, including longitudinal damage extending 634 nm below the surface.  
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14 The depth of the longitudinal damage is larger than the 146 nm ion-penetration depth predicted by  
15 SRIM for 35 keV He<sup>+</sup> in c-C, which will be considered in further detail in discussions of figure 3.  
16  
17 Figure 2e shows the results of electron energy-loss spectroscopy (EELS) analyses, where a shift  
18 in the energy of volume plasmon peak of c-C was observed and attributed to FHIB-induced  
19 damage. The volume plasmon energy depends on the density of the material and as such we used  
20 the shift in volume plasmon energy to estimate the change in density of the material due to  
21 interactions with the FHIB.<sup>52</sup> We estimated a density reduction of approximately 50% going from  
22 pristine c-C (3.47 g/cm<sup>3</sup>) to damaged diamond (1.79 g/cm<sup>3</sup>). The supplementary information  
23 describes how the estimation of density using EELS was conducted. Figures 2f-g show the external  
24 structure of a 94-nm-thick c-C membrane after a FHIB point exposure at the edge of the membrane.  
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26 The longitudinal damage range observed is 938 nm, which is approximately 300 nm larger than  
27 the value shown in figure 2d. This comparison implies that FHIB-induced morphology changes  
28 depend on exposure method and location. Figure 2h shows a TEM image of a 87-nm-thick c-C  
29 membrane exposed to a 10 keV FHIB using a point-exposure at the center of the membrane. Strong  
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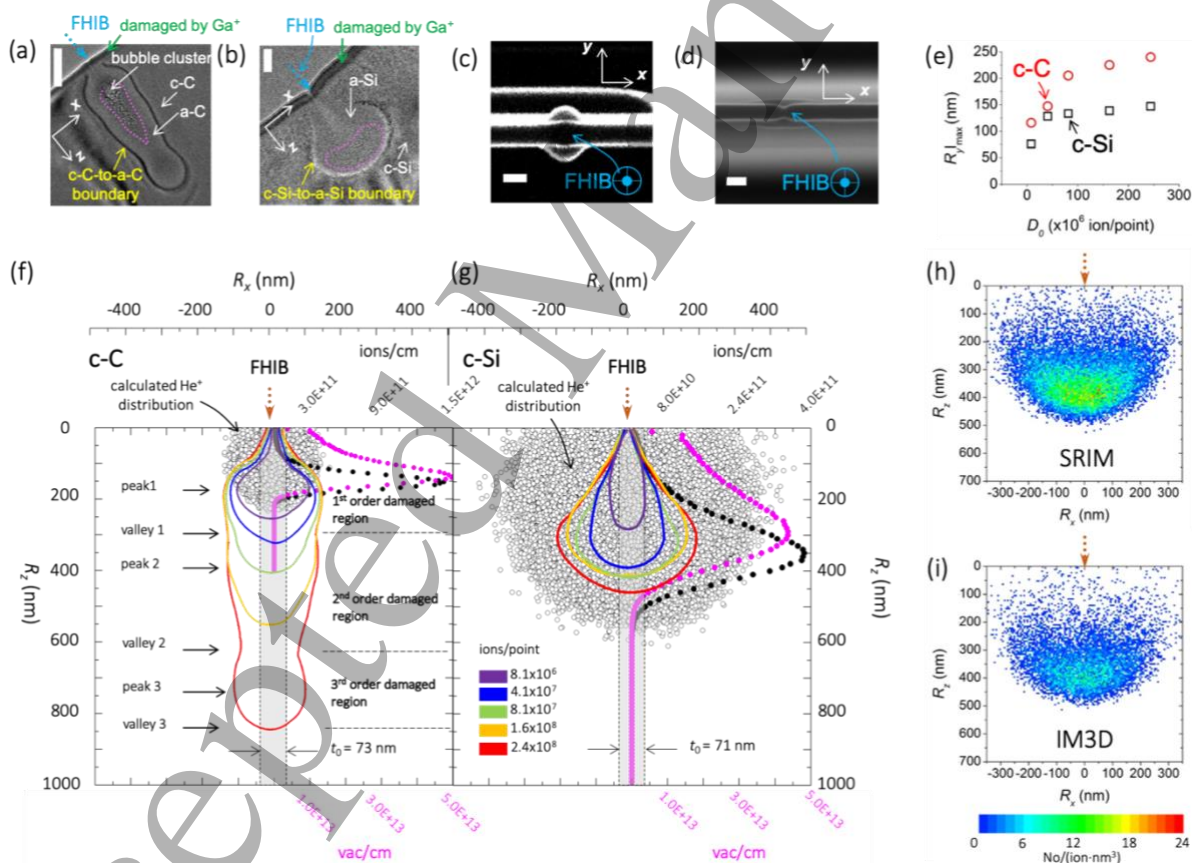
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3 surface sputtering was observed near the point where the FHIB entered the sample as He<sup>+</sup> loses  
4 more energy via nuclear interactions at 10 keV relative to 35 keV. Nuclear losses for 10 keV and  
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8 35 keV He<sup>+</sup> in c-C are 23.24 eV/Å and 10.43 eV/Å respectively as calculated by SRIM.  
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10 The results shown in figures 1 and 2 summarize the FHIB-induced damage in c-Si and c-C  
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12 observed in this work and demonstrates that our method enables detailed observation of this  
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14 damage. In the following sections, we will describe the results of targeted FHIB irradiation in c-Si  
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16 and c-C nanostructures with respect to dose ( $D_0$ ), membrane thickness ( $t_0$ ), crystal orientation, and  
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18 ion energy ( $E_0$ ).  
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24 Figure 3 presents the results of our investigation of the effect of FHIB dose ( $D_0$ ) and material (c-C  
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26 vs. c-Si) on FHIB-induced morphology changes using membranes having similar thicknesses ( $t_0$ ).  
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28 In order to study the effects of dose and composition, we prepared membranes from c-C and c-Si  
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30 with  $t_0$  of 73 nm and 71 nm, respectively. Each membrane used had the same crystal orientation  
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32 ( $\hat{x} = \hat{y} = [110]$  and  $\hat{z} = [001]$ ). We performed a point-exposure with 35 keV He<sup>+</sup> at a central position  
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34 on the membrane, normal to the  $x$ - $y$  plane of each membrane, with five different values of  $D_0$  ( $8.1$   
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36  $\times 10^6$ ,  $4.1 \times 10^7$ ,  $8.1 \times 10^7$ ,  $1.6 \times 10^8$ , and  $2.4 \times 10^8$  ions/point), where each point has an effective  
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38 focal area of about 1 nm<sup>2</sup>.  
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42 Figures 3a-b show representative results observed by TEM in c-C and c-Si, respectively  
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44 ( $D_0 = 2.4 \times 10^8$  ions/point). These images show the apparent boundary between damaged and  
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46 undamaged regions in c-C and c-Si. Specifically, c-C exhibits an extended damage range along  
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48 the  $z$ -axis ( $R_{z|\max} = 857$  nm) with three peaks in  $R_x$  observed moving along the  $z$ -axis and increased  
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50 gas bubble formation, *e.g.* nanobubbles and clusters thereof, which we refer to as bubble clusters.  
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52  
53 In the case of c-Si, the damaged region shown in figure 3b is similar to the damaged region reported  
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in previous studies with bulk c-Si substrates.<sup>33,51</sup> However, in those works only nanobubbles were observed in c-Si even though the applied dose exceeded that required for bubble cluster formation ( $D_0$  of  $10^{17}$  ions/cm<sup>2</sup>).<sup>32</sup> We will discuss the reported absence of bubble clusters later in the text when we discuss ion leakage effects. Figures 3c-d show SEM images of FHIB-exposed c-C and c-Si, respectively ( $D_0 = 2.4 \times 10^8$  ions/point). These images show external damage in the form of volume deformation. Specifically, c-C exhibits extended damage with a measured  $R_{y/\max}$  value of 240 nm, which is 1.6 times larger than  $R_{y/\max}$  for c-Si. The increased gas bubble formation seen in c-C is likely to promote volume deformation as seen in previous reports for Si and Cu.<sup>32,33,53</sup>



**Figure 3.** He<sup>+</sup>-induced damage in c-C and c-Si as a function of  $D_0$ . White scale bars in (a-d) are 100 nm. (a-b) TEM images of ( $x$ - $z$  plane) He<sup>+</sup>-exposed c-C membranes (a) and c-Si (b) (ion dose =  $2.4 \times 10^8$  ions/point). The boundaries between crystalline and amorphous regions in c-C and c-Si are distinguishable. Measured  $R_{c|\max}$  for c-C and c-Si are 857 nm and 433 nm, respectively. Pink

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3 dotted lines in each figure show the boundary of regions where gas bubbles formed. (c-d) SEM  
4 images of the surface morphology ( $x$ - $y$  plane) of He<sup>+</sup>-exposed c-C (c) and c-Si (d) membranes in  
5 the same samples as (a-b). Measured  $R_{y|\max}$  for c-C and c-Si are 240 nm and 147 nm, respectively.  
6 (e) Measured  $R_{y|\max}$  for c-C and c-Si ( $x$ - $y$  plane) as a function of  $D_0$ . (f-g) Profiles of He<sup>+</sup>-induced  
7 damage in c-C and c-Si ( $x$ - $z$  plane) as a function of  $D_0$ , obtained from TEM images. Distribution  
8 of He<sup>+</sup> projected in the  $x$ - $z$  plane, He<sup>+</sup> density (ions/cm) and vacancy density (vac/cm) along  $z$ -  
9 axis, calculated from SRIM are overlaid (black and magenta dots respectively). The final locations  
10 of He<sup>+</sup> were projected onto the  $x$ - $z$  plane. He<sup>+</sup> and vacancy densities were calculated using  $D_0 =$   
11  $8.0 \times 10^6$  ions/point. In c-C (f), three peaks and troughs in the width of the damaged region are  
12 observed moving along the  $z$ -axis (red trace) for  $D_0 = 2.4 \times 10^8$  ions/point. Increasing numbers of  
13 peaks and troughs emerge with increasing dose. These peaks and troughs are used to define higher  
14 order damages regions as shown. Virtual membranes ( $y$ - $z$  plane) with  $t_0$  of 73 nm for c-C (f) and  
15 71 nm for c-Si (g) are overlaid to show He<sup>+</sup> leakage due to the membrane geometry. (h-i) 2D He<sup>+</sup>  
16 distribution on the  $x$ - $z$  plane at the center of the  $y$ -axis in c-Si without (h) and with (i) consideration  
17 of finite membrane thickness ( $t_0 = 73$  nm) using IM3D.

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24 Figure 3e summarizes the observed trends in measured values of  $R_{y|\max}$  as a function of  $D_0$   
25 for c-C and c-Si.  $R_{y|\max}$  is larger for c-C than for c-Si and increases in both materials with  $D_0$ . The  
26 larger values of  $R_{y|\max}$  in c-C relative to c-Si are consistent with the larger lattice parameter in c-  
27 Si, which supports an increased probability of helium escape for c-Si, while the increase in  $R_{y|\max}$   
28 with ion dose is expected based on the decrease in material density during damage formation and  
29 helium accumulation within the material. Figures S2-4 in the supplementary material show  
30 micrographs for other values of  $D_0$ . Figures 3f-g summarize the evolution of damaged regions in  
31 the  $x$ - $z$  plane as a function of  $D_0$  with profiles of the damaged regions observed in TEM images of  
32 c-C and c-Si represented by solid colored lines. Figures 3f-g also include three SRIM simulation  
33 results, He<sup>+</sup> distribution projected in the  $x$ - $z$  plane, and densities of He<sup>+</sup> and vacancies along the  $z$ -  
34 axis. The supplementary material describes SRIM simulations in detail. Plotted densities of He<sup>+</sup>  
35 and vacancies were calculated using the minimum  $D_0$  of  $8.1 \times 10^6$  ions, because SRIM does not  
36 account for dynamic processes such as density reduction and gas bubble formation observed at  
37 higher doses.<sup>10,48,52</sup> Thus, comparison of experimental and simulation results is reasonable at doses  
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3 of  $8.1 \times 10^6$  ions where bubbles are not formed in both materials. The simulated He<sup>+</sup> distribution  
4 maps differ from experimental profiles in both c-C and c-Si. The simulated densities of He<sup>+</sup> and  
5 vacancies along the  $z$ -axis show only a single peak in both c-C and c-Si, while in experiments c-C  
6 exhibited multiple peaks. In figure 3f, we describe the multiple peaks and valleys in the boundary  
7 between amorphous and crystalline material along the  $z$ -axis as separating  $N^{\text{th}}$ -order damaged  
8 regions. These labels will be used when discussing long-range ion propagation below. We  
9 determined the locations of peaks and valleys by observing the widest and narrowest  $R_{x/\text{max}}$  values.  
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19 The material dependence of ion-induced damage and deformation observed is related to  
20 the thickness of the nanostructures. This dependence occurs because the calculated radial damage  
21 range ( $R_r$ ) in each material is larger than half the membrane thickness  $t_0/2 \cong 37$  nm, and so helium  
22 can escape from the material in a process that we term “ion leakage”. The calculated values of  $R_r$   
23 for c-C and c-Si using SRIM are  $40.9 \pm 21.5$  nm and  $145.3 \pm 70.8$  nm, respectively. Figures 3f-g  
24 show the effect of membrane geometry by overlaying two grey-colored bars on simulation and  
25 experimental results representing membrane thickness. Inspection of the simulated He<sup>+</sup>  
26 distribution with respect to  $t_0$  suggests that more He<sup>+</sup> scatters out of a virtual membrane in c-Si  
27 than in c-C, likely due to the reduced stopping power of 35 keV He<sup>+</sup> ions in c-Si ( $11.6 \text{ eV/\AA}$ )  
28 compared to c-C ( $29.8 \text{ eV/\AA}$ ).  
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42 We quantified the number of He<sup>+</sup> ions coming to rest inside the membrane as the  
43 probability of He<sup>+</sup> accumulation ( $P_{\text{acc}}$ ), where the probability of escape was  $P_{\text{esc}} = 1 - P_{\text{acc}}$  for a  
44 given  $t_0$ . The resulting values calculated using SRIM  $P_{\text{acc}}^{\text{SRIM}} = 0.73$  (c-C) and  $P_{\text{acc}}^{\text{SRIM}} = 0.23$  (c-Si).  
45 This result indicates that the probability of He<sup>+</sup> trapping is 3.17 times larger in c-C than in c-Si due  
46 to larger loss of He<sup>+</sup> kinetic energy per collision in c-C ( $m_{\text{He}}$  is closer to  $m_{\text{C}}$  than  $m_{\text{Si}}$ ). This trapping  
47 contributes not only to gas bubble nucleation, but also to subsequent collision cascades between  
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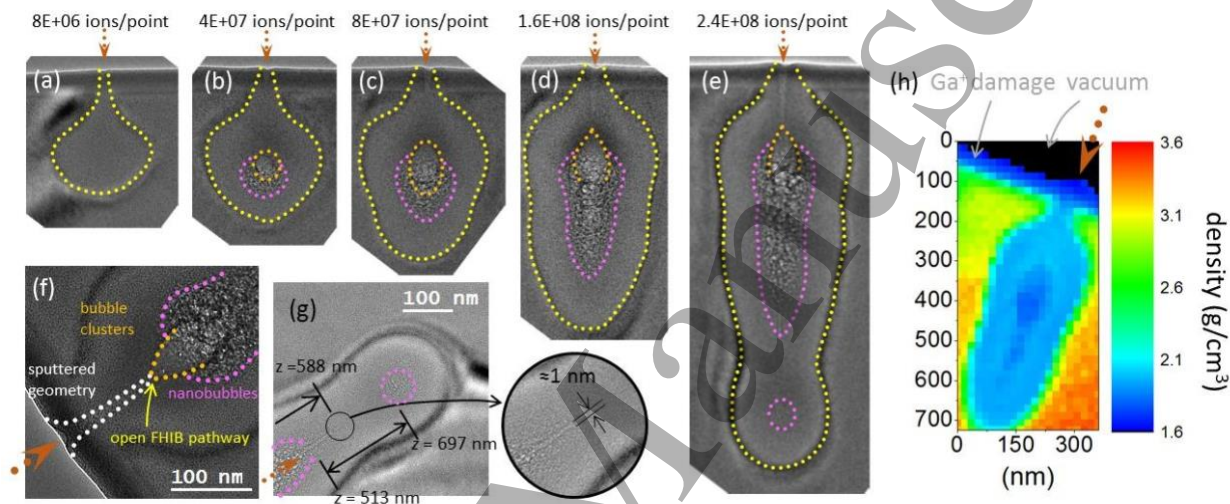
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3 incident primary ions and trapped helium, resulting in additional radiation damage in c-C, where  
4 the probability of ion leakage is lower than in c-Si. However, this SRIM calculation includes He<sup>+</sup>  
5 recoil back into the nanostructure, which cannot happen once the He<sup>+</sup> has left the film, as SRIM  
6 cannot handle real 3D geometries.<sup>54</sup> Thus, we performed a full 3D Monte Carlo simulation using  
7 IM3D, which accounts for the leakage of He<sup>+</sup> in arbitrary 3D geometries. The simulated  
8 probabilities for accumulation using IM3D,  $P_{acc}^{IM3D}$ , were 0.69 and 0.08 in c-C and c-Si,  
9 respectively. Thus, the IM3D simulation results differ significantly from those obtained from  
10 SRIM.  
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21 Given the high  $P_{acc}$  in c-C, gas bubbles and atomic displacements are more probable in c-C  
22 than in c-Si. This increase in damage results in  $R_{y|max}$  in c-C being 2.25 times larger than that in  
23 c-Si at the maximum  $D_0$ , as shown in figures 3c-e. The supplementary material describes the  
24 calculation of  $P_{acc}$  and  $P_{esc}$  in detail. Figure S5 in the supplementary material shows  $P_{acc}$  as a  
25 function of  $t_0$  for both c-C and c-Si.  
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33 The ion leakage effect enables us to explain the absence of bubble clusters in c-Si (figure  
34 3b) at  $D_0 = 2.4 \times 10^8$  ions/point, equivalent to  $2.4 \times 10^{22}$  ions/cm<sup>2</sup>, since each point has an effective  
35 area of about 1 nm<sup>2</sup>. This areal dose density is four and five orders of magnitude higher than the  
36 nucleation doses for nanobubbles and bubble clusters, respectively.<sup>32</sup> We would thus naively  
37 expect bubble clusters to form. By accounting for dose from the proximity effect and  $P_{acc}$ , the  
38 effective  $D_0$  in figure 3b reduces to about  $1.7 \times 10^{17}$  ions/cm<sup>2</sup> (SRIM) or  $6.1 \times 10^{16}$  ion/cm<sup>2</sup>  
39 (IM3D). The effective  $D_0$  obtained using IM3D is thus below the nanobubble nucleation dose of  
40  $10^{17}$  ions/cm<sup>2</sup> reported in previous work.<sup>32</sup> While estimates of bubble nucleation dose thresholds  
41 are admittedly inexact, the fact that bubbles are indeed not observed does support the notion that  
42 IM3D describes ion-nanostructure interactions more accurately than SRIM.  
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Additionally, we provide an example of the necessity for consideration of  $\text{He}^+$  leakage when computing ion-solid interactions, in figures 3h-i. The distributions calculated by SRIM (figure 3h) differ significantly from those calculated by IM3D (figure 3i). As IM3D accounts for the three-dimensional structure of the system, while SRIM does not, we presume figure 3i gives a more accurate estimate of the actual behavior of the process.



**Figure 4.** Evolution of long-range ion-propagation with increasing ion dose. TEM images in (a-e) were used to form the contours shown in figure 3f. The dotted brown arrow indicates the direction of the incident FHIB. Yellow dashed lines, drawn by hand, mark the crystal-to-amorphous boundary in the material. This boundary forms a geometric constraint as explained in the text. (a) TEM image shows the damaged amorphous region without gas bubbles. (b) TEM image shows the onset of nucleation of nanobubbles (dashed pink line) and bubble clusters (dashed orange line). (c-d) TEM images show the onset of the 2<sup>nd</sup> order damaged regions (as defined in figure 3f) with extended nanobubble formation along the  $z$ -axis. (e) TEM shows further extended  $\text{He}^+$  propagation, resulting in a 3<sup>rd</sup> order damaged region ( $R_{z|\text{max}} = 857 \text{ nm}$ ). (f) TEM image shows the connection between the sputtered volume and bubble clusters, which act as an exit for helium gas and an entrance for the FHIB into the newly formed cavity. A white dotted line shows the geometric boundary of the sputtered volume. (g) Image shows a magnified view of a region 588 nm beneath the surface shown in figure 4e. This image shows ultra-fine features with 1-nm lateral extent inside the membrane. (h) 2D density map, calculated using the volume plasmon energy measured by EELS. The specimen used here is shown in figure 2a. The measured sample density had a range of 1.72-3.47 g/cm<sup>3</sup>. The region where helium gas bubbles formed showed the lowest density values.

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3 Figure 4 describes the evolution of long-range ion propagation in c-C as a function of  $D_0$ . The  
4 damaged region at the lowest  $D_0$  of  $8 \times 10^6$  ions/point in figure 4a does not include bubbles, which  
5 indicates that the  $R_{y|_{\max}}$  measured in figure 3e first occurred by a phase transition from c-C to  
6 amorphous carbon (a-C). We compare the vacancy density calculated in figure 3f with the  
7 threshold vacancy density of  $1-9 \times 10^{22}$  vac/cm<sup>3</sup> required to convert c-C to a-C under broadband  
8 helium ion implantation,<sup>52,55</sup> due to the absence of existing experimental data using focused beams  
9 with c-C. Applying the proximity effect and  $P_{\text{acc}}$  corrections as before, the reduced vacancy  
10 densities are about  $7.3 \times 10^{22}$  vac/cm<sup>3</sup> (SRIM) and  $6.9 \times 10^{22}$  vac/cm<sup>3</sup> (IM3D). These values are  
11 consistent with the threshold vacancy density from the literature mentioned above.  
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24 The transition to an amorphous state not only leads to lower density, but also forms a  
25 geometric constraint at the interface between the amorphous and crystalline phases of the material  
26 where the rigid crystalline material constrains the ductile amorphous material. The yellow dashed  
27 line in figure 4a shows the boundary of the geometric constraint, which evolves with increasing  
28 He<sup>+</sup> irradiation dose as shown in figures 4b-e. When the damaged amorphous region extends along  
29 the y-axis to the surface (*i.e.* when  $t_0 < R_{y|_{\max}}$ ), the surface is readily deformed resulting in the  
30 observed 'bloating', an effect we take advantage of below as part of the "blow forming" process.  
31 This bloating occurs because there is no longer a c-C layer at the surface acting as a geometrical  
32 constraint to the ductile amorphous material.  
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44 To establish the local material density in FHIB-irradiated c-C, we used electron energy loss  
45 spectroscopy (EELS). The estimated average density in a-C ( $\rho_{a-c}$ ) was 2.04 g/cm<sup>3</sup> (figure S6),  
46 which indicates a 42% drop in density relative to c-C. This  $\rho_{a-c}$  of 2.04 g/cm<sup>3</sup> is close to that  
47 expected for stable amorphous allotropes of carbon having densities of 2.06-2.35 g/cm<sup>3</sup>, measured  
48 after ion implantation and micro-beam irradiation at 50-500 keV with various ion species.<sup>52,55,56</sup>  
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3 The reduction in density also implies a drop in the elastic modulus and the material becomes more  
4 ductile as a-C is formed.<sup>55,57</sup>  
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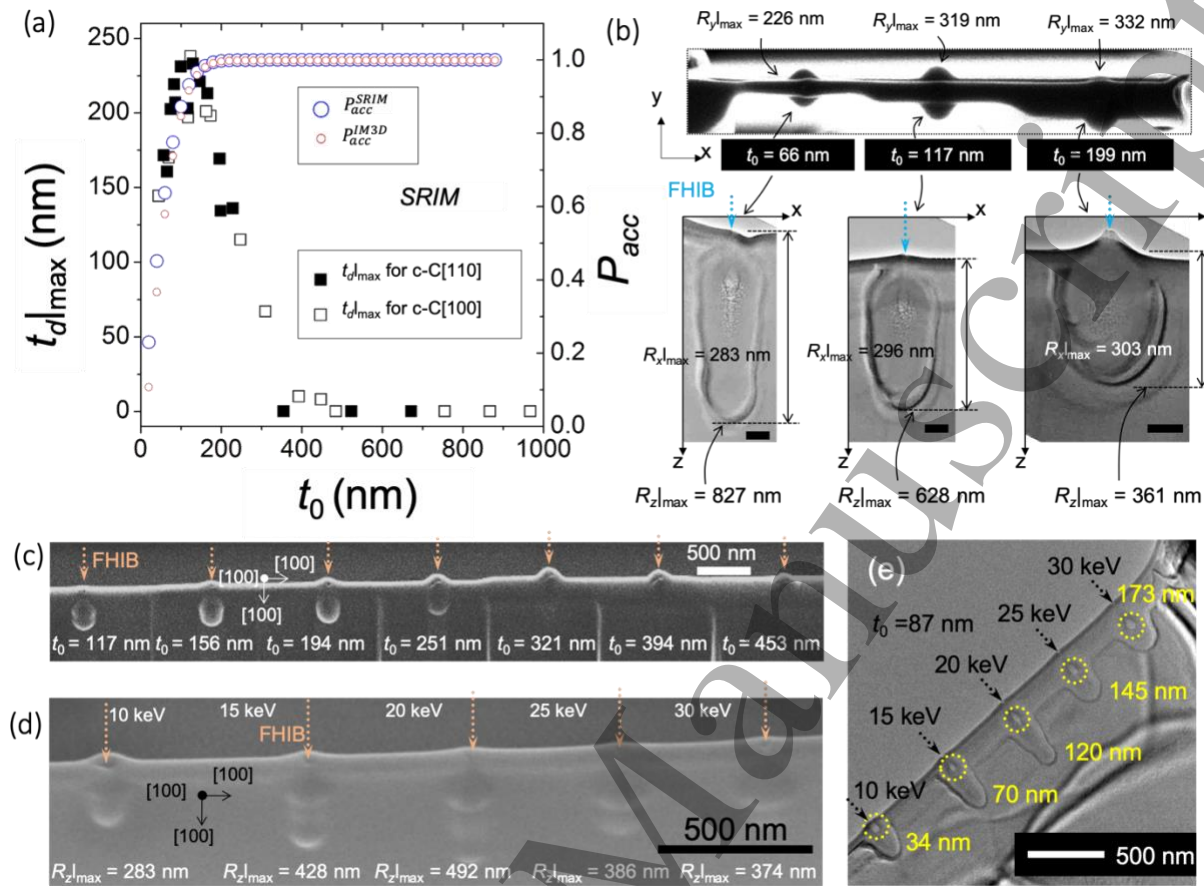
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8 It is also notable that the simulated He<sup>+</sup> distribution in c-C closely matched the observed  
9 damaged region in the experiment at the lowest  $D_0$  of  $8 \times 10^6$  ions/point, as shown in figure 3f,  
10 presumably because the nucleation of gas bubbles did not occur and ion leakage in c-C was not  
11 significant.  
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17 Figures 4b-e show the formation and development of nanobubbles in c-C. Figure 4b shows  
18 the onset of both nanobubbles and bubble clusters at  $D_0$  of  $4 \times 10^6$  ions/point. Above this dose,  
19 volume deformation is likely to be induced by gas bubble formation as the internal pressure,  $p_i$ ,  
20 increases in the membrane (figures 4c-e). Figure 4c shows the growth of helium bubbles within a  
21 1<sup>st</sup> order damaged region and at the onset of 2<sup>nd</sup> order damage. Figure 4d shows the continuation  
22 of those two processes with additional FHIB irradiation. The onset of 2<sup>nd</sup> order damage results  
23 from increased helium and vacancy accumulation deeper within the sample and thus greater helium  
24 penetration as scattering is reduced in the lower density material formed by accumulation of  
25 helium and vacancies. A region of 3<sup>rd</sup> order damage is observed in figure 4e at a dose of  $2.4 \times 10^8$   
26 ions/point. The 3<sup>rd</sup> order region is separated from the 2<sup>nd</sup> order region by a bubble-free region at  
27  $z = 513$  nm. The disappearance of nanobubbles in this region may be due to helium release, which  
28 can occur due to the rupture of deformed surfaces by high-pressure gas bubbles.<sup>53</sup> In this case, the  
29 helium gas may release through the entrance channel that formed due to sputtering and bubble  
30 clusters, as shown in figure 4f. Therefore, He<sup>+</sup> can propagate through the formed internal cavity  
31 until it strikes sub-surface vacuum-carbon interfaces.  
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51 Figure 4g shows evidence of long-range FHIB propagation as a remnant of an ultra-fine  
52 FHIB ( $\approx 1$  nm lateral width) is observed at  $z = 588$  nm. This long-range FHIB propagation is likely  
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3 responsible for creating the 3<sup>rd</sup> order volume deformation. The depth of field of FHIB is estimated  
4 to be  $\sim 1 \mu\text{m}$  based on the image resolution (1 nm) and the beam convergence angle (1 mrad)<sup>58</sup>,  
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6 and supports this observation.  
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10 We have shown that FHIB exposure of c-C results in damage to the material and an  
11 associated decrease in material density. Here, we estimate changes in the density of FHIB-  
12 irradiated c-C membranes containing gas bubbles using EELS. Figure 4h shows a measured 2D  
13 density map with densities ranging from 1.72-3.47 g/cm<sup>3</sup>. Based on the maximum density of a-C  
14 (2.95 g/cm<sup>3</sup>) measured in reference 49, we divided the measured densities into two ranges: c-C for  
15 densities of 2.96-3.47 g/cm<sup>3</sup> and a-C for 1.72-2.95 g/cm<sup>3</sup>. Figures S7-S8 in the supplementary  
16 material shows more detailed density maps. Specifically, the density near nanoscale voids is lower  
17 than that expected for stable carbon allotropes (2.15-2.35 g/cm<sup>3</sup>). A density of less than 2.15 g/cm<sup>3</sup>  
18 supports plastic deformation in highly damaged regions (a-C) as observed in figures 2-4. A density  
19 less than that of stable allotropes caused by FHIB irradiation could occur due to tensile strain,  
20 which in turn leads to volume deformation, nanobubble formation, and transmission milling.<sup>51,59</sup>  
21 These combined phenomena appear on the outer surface in figure 2c. Additionally, secondary  
22 sputtering by scattered ions and sputtered C atoms inside the membrane may also play a role. EELS  
23 analysis also revealed a peak in the 4-8 eV energy-loss range for a-C (figures 2e and S9). This  
24 peak is associated with sp<sup>2</sup>-hybridized carbon, shifting to lower energy and increasing in intensity  
25 with proximity to the path of the primary ion beam. Charged-particle beams have previously been  
26 used to convert sp<sup>3</sup> allotropes of carbon into sp<sup>2</sup> carbon, which is consistent with our  
27 observations.<sup>52,60</sup>  
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**Figure 5.** He<sup>+</sup>-induced damage in c-C as a function of  $t_0$  and  $E_0$ . All dotted arrows represent locations and directions of the incident FHIB. (a-c) Influence of He<sup>+</sup>-induced damage as a function of  $t_0$ . A point exposure method was used to irradiate a point at the center of membranes with a 35 keV FHIB and  $D_0$  of  $2.4 \times 10^8$  ions/point. (a) We measured  $t_d|_{\max}$  versus  $t_0$ . ■:  $t_d|_{\max}$  of c-C[110], □:  $t_d|_{\max}$  of c-C[100], and  $P_{\text{acc}}$ , calculated from SRIM(○) and IM3D(◊), as a function of  $t_0$  is overlaid. Both materials show similar changes in  $t_d|_{\max}$ , and  $t_0$  has a significant effect on  $t_d|_{\max}$ . (b) Top: SEM image of exposed c-C[100] recorded normal to the  $x$ - $y$  plane. Bottom: TEM images of exposed c-C[100] recorded normal to the  $x$ - $z$  plane. Measured  $R_{y|_{\max}}$  and  $R_{z|_{\max}}$  for three different values of  $t_0$  of 66 nm, 117 nm, and 199 nm are indicated. Both  $R_{z|_{\max}}$  and gas bubble formation are reduced as  $t_0$  increases. Black scale bars are 100 nm. (c) SEM image showing more test specimens exposed to He<sup>+</sup> as in (a-b). Volume deformation along the  $z$ -axis decreases with  $t_0$  and upward volume deformation dominates for  $t_0 > 194$  nm. (d-e) Influence of  $E_0$  on He<sup>+</sup>-induced damage. An 87 nm thick c-C[100] membrane was exposed with a fixed ion dose of  $8 \times 10^7$  ions/point. SEM (d) and TEM (e) images show external and internal damage, respectively. In (e), dotted yellow circles and numbers represent locations of gas bubble clusters along the  $z$ -axis and their maximum lateral width, respectively. Damage appearing along the  $z$ -direction did not increase linearly with  $E_0$ .

Figure 5 summarizes the results of our study of the effects of material thickness and ion energy on FHIB-induced damage in c-C. We considered two crystal orientations,  $\hat{x} = \hat{y} = [110]$  and  $[100]$  in this work (crystal orientation was observed to have a negligible effect on the magnitude of deformation). Hereafter, each is referred to as c-C[110] and c-C[100]. A variety of values of  $t_0$  ranging from 60 nm to 1  $\mu\text{m}$  was considered for each crystal orientation. We define the deformed thickness  $td|_{\text{max}}$  for each membrane as the difference between  $R_y|_{\text{max}}$  and  $t_0$ . Most membranes were prepared from bulk c-C substrates, and some membranes were prepared on a TEM grid for subsequent analysis by TEM. A 35 keV FHIB was used to expose the center of samples with a fixed  $D_0$  of  $2.4 \times 10^8$  ions/point. Figures S10-13 show the collected micrographs for all relevant experimental results.

Figures 5a-c show the effect of  $t_0$  on the deformation. Figure 5a shows the measured  $td|_{\text{max}}$  for c-C[110] and c-C[100] as a function of  $t_0$ , which clearly shows that  $td|_{\text{max}}$  depends on thickness, while crystal orientation has a negligible effect. Figure 5b shows SEM (top) and TEM (bottom) images in  $x$ - $y$  and  $x$ - $z$  planes for He<sup>+</sup>-exposed c-C[100] for three different values of  $t_0$ . Figure 5c shows more experimental results of He<sup>+</sup>-exposed c-C[100] inspected by SEM. As  $t_0$  increases, figure 5a shows that the magnitude of deformation,  $td|_{\text{max}}$ , first increases and then decreases, and figures 5b-c shows that  $R_z|_{\text{max}}$  decreases monotonically.

The behavior of  $td|_{\text{max}}$  in figures 5a-c is presumably a consequence of the maximum internal pressure ( $p_i|_{\text{max}}$ ) that can build up inside membranes for the 1<sup>st</sup> order volume deformation before allowing higher order deformation. We define a deformation resistance factor  $k$  to determine  $p_i|_{\text{max}}$ . The parameter  $k$  may have the same form of flexural rigidity for the case of a circular flat plate subjected to uniform pressure with a clamped edge.<sup>61</sup> This is valid if we assume that pressurized regions are constant as a circular shape in the  $x$ - $y$  plane at the 1<sup>st</sup> order damage region and materials

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3 are homogeneous in all experiments. Then,  $k$  is simply a monotonically increasing function of  $t_0$ ,  
4 because a thicker membrane will be more difficult to deform under a constant pressure.  
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6 Consequently, we can summarize three important points as follows: (1)  $p_{i|\max}$  scales with  $k$  to a  
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8 maximum value, which is equivalent to that of a bulk sample. (2)  $p_i$  increases with the product of  
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10 dose and the probability of helium accumulation ( $D_0 \cdot P_{\text{acc}}$ ). (3)  $t_{d|\max}$  will reach a maximum  
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12 deformation  $T_{d|\max}$  when  $p_i = p_{i|\max}$ . Additional pressure above  $p_{i|\max}$  will contribute to the creation  
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14 of higher order damage regions and volume deformation.  
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19 The quantitative estimation of  $k$  is not considered in this work for two reasons: (1) Material  
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21 properties of membranes change dynamically and are non-homogeneous, as shown in figure 4h.  
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23 (2) An increase in the surrounding volume of c-C relative to a-C produced by  $\text{He}^+$  irradiation leads  
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25 to different boundary conditions at each  $t_0$ . Specifically, when  $t_0 \geq 2R_r$ , a composite bi-layer will  
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27 be formed consisting of a-C (interior) and c-C (exterior), which will lead to a change in mechanical  
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29 properties, as the elastic modulus of c-C is of the order of ten times larger than that of a-C.<sup>57</sup>  
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33 In summary, we can best explain the effect of thickness on  $t_{d|\max}$  by subdividing the  
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35 thickness into three different regimes (see figure 5a) as follows. In the first regime, ( $t_0 \leq 130$  nm),  
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37 material deformation increases as  $t_0$  increases. This increase is consistent with an increase in  $P_{\text{acc}}$   
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39 with increasing thickness. As  $t_0$  increases, there is less helium leakage and more helium  
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41 accumulates in the nanostructure resulting in greater deformation. In the second regime, where  
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43  $130 \text{ nm} \leq t_0 \leq 375 \text{ nm}$ ,  $t_{d|\max}$  decreases as  $t_0$  increases. At larger value of  $t_0$ , the a-C region formed  
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45 by the FHIB no longer extends all the way to the surface of the membrane along the  $y$ -axis.  
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47 Consequently, a c-C layer exists at the surface that acts to constrain the ductile a-C and reduce  
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49 deformation. This c-C layer increases in thickness as  $t_0$  increases and thus reduces deformation. In  
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51 the third regime where  $t_0 \geq 375$  nm, no change in  $t_{d|\max}$  is observed at all. We interpret this as a  
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3 micro-to-bulk transition, implying that the materials response to ion irradiation can be regarded as  
4 that of the bulk material ( $k = 1$ ).  
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7 Unlike  $td|_{\max}$ ,  $R_z|_{\max}$  decreases monotonically with increasing  $t_0$  before reaching a minimum  
8 at value when  $t_0 > 375$  nm. This suggests that the reduction in material density along the ion-beam  
9 axis is lower in thicker samples for a given dose, which is consistent with an increase in  $k$  with  
10 increasing thickness. This implies that the rate of increase of  $k$  with respect to  $t_0$  is larger than that  
11 of  $D_0 \cdot P_{\text{acc}}$ . If it were not,  $R_z|_{\max}$  would follow the same trend as that of  $td|_{\max}$  with increasing  $t_0$ . The  
12 rapid increase of  $k$  with  $t_0$  implies that  $k$  is very small when  $t_0 < 2 \cdot R_r$ . This prediction is reasonable  
13 because c-C membranes can be fully amorphized in the  $y$ - $z$  plane for  $t_0 < 2 \cdot R_r$ . In fact, the longest  
14  $R_z|_{\max}$  of 827 nm was observed when  $P_{\text{acc}} = 0.6125$  at  $t_0 = 66$  nm. Additionally, when  $t_0 > 130$  nm,  
15 volume deformation also occurred in an upward direction, as shown in figures 5b-c. This upward  
16 volume deformation is a result of deformation toward the weakest part of the FHIB-damaged area  
17 with stress concentration at the sputtered point of incidence of the FHIB. The upward volume  
18 deformation is typical of FHIB interactions with bulk materials.<sup>32,33</sup>  
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36 The measured  $R_x|_{\max}$ ,  $R_y|_{\max}$  and  $R_z|_{\max}$  are similar for both crystal orientations studied. For  
37 instance, c-C[100] with  $t_0$  of 66 nm exhibited  $R_x|_{\max}$ ,  $R_y|_{\max}$  and  $R_z|_{\max}$  values of 266 nm, 226 nm,  
38 and 827 nm, respectively (figure 5b). These values are comparable to c-C[110] where  $t_0$  was 73  
39 nm (figure 3b) and  $R_x|_{\max}$ ,  $R_y|_{\max}$  and  $R_z|_{\max}$  were 272 nm, 240 nm, and 854 nm, respectively. The  
40 negligible effect of crystal orientation is likely related to the high He<sup>+</sup> dose, which collapses any  
41 anisotropy in mechanical properties and material density. In other words, a  $D_0$  of  $8.1 \times 10^6$   
42 ions/point was sufficient to convert c-C to a-C, as shown in figure 4a. The FHIB-induced  
43 conversion of c-C into amorphous carbon is likely to suppress ion channeling, which would exhibit  
44 a dependence on crystal orientation. Figure 5a also shows calculated  $P_{\text{acc}}^{\text{SRIM}}$  and  $P_{\text{acc}}^{\text{IM3D}}$  as a function  
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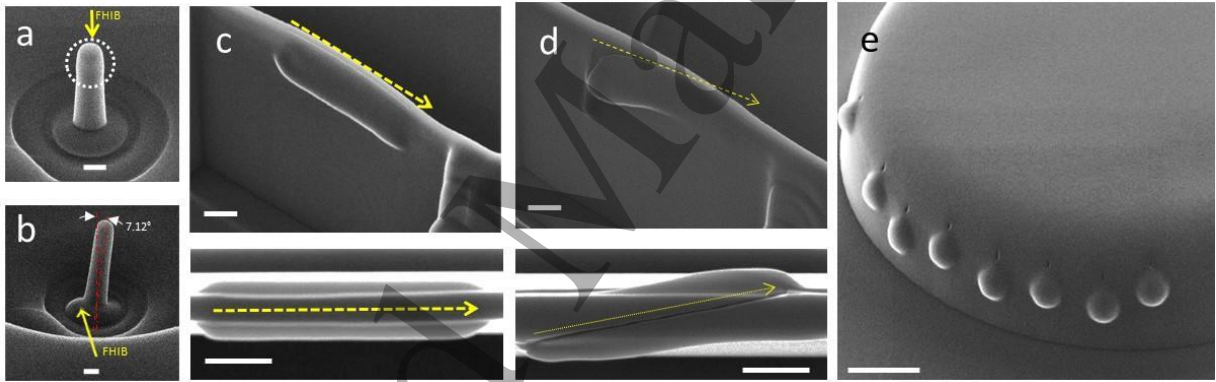


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3 of  $t_0$ . As  $t_0$  increases, both values increased and are comparable with less than a 2% difference  
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5 when  $t_0 \geq 120$  nm.  
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8 In figures 5d-e, we show the effect of beam energy on deformation. Figure 5d shows SEM  
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10 and TEM micrographs, respectively, of c-C[100] membranes with thickness  $t_0 = 87$  nm implanted  
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12 with different values of  $E_0$  (see figure S16 for additional micrographs). Five different ion energies  
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14 of 10, 15, 20, 25, and 30 keV were used with a fixed  $D_0$  of  $8 \times 10^7$  ions/point. As  $E_0$  increases, the  
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16 locations of bubble clusters shifted further away from the membrane edge along the  $z$ -axis and  
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18 upward surface swelling was reduced. The shift in the location of bubbles can be explained by the  
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20 increased  $\text{He}^+$  penetration depth with increasing  $E_0$ . Correspondingly, peak locations of densities  
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22 of  $\text{He}^+$  and vacancies in the longitudinal direction shift deeper.<sup>11,32</sup>  
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26 In contrast to the monotonic shift in bubble location,  $R_{z|\max}$  did not show a monotonic  
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28 increase with  $E_0$ , instead decreasing from 492 nm to 386 nm as  $E_0$  increased from 20 keV to  
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30 25 keV. The origin of this change in  $R_{z|\max}$  with ion energy may be related to the following three  
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32 physical processes as  $E_0$  increases (see figures S17-19 for supporting data): (1) The ratio of  
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34 electronic to nuclear stopping power decreases, resulting in increased simulated  $R_{x,y,z}$  and a  
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36 decrease in simulated sputter yield. (2) Densities and peak locations of  $\text{He}^+$  and vacancies in the  
37  
38 longitudinal direction decrease and increase, respectively. This fact implies that not only is greater  
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40 delivery of  $\text{He}^+$  required to coalesce nanobubbles into bubble clusters, but also larger bubbles are  
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42 likely to be created. The dashed yellow circle in figure 5e shows that the maximum lateral width  
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44 of bubble clusters increases as  $E_0$  increases. (3) At a given  $t_0 = 87$  nm, the probability of helium  
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46 accumulation ( $P_{\text{acc}}$ ) decreases, implying less damage. As  $E_0$  increases,  $R_{x,y,z}$  increases and the  
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48 density of  $\text{He}^+$  and  $P_{\text{acc}}$  decrease. Comparing these three processes with experimental results, we  
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50 can explain the non-linearity as follows: the change in  $R_{z|\max}$  follows the tendency of the first  
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process when  $E_0 < 25$  keV. This is presumably due to reduced significance of  $P_{acc}$ , because most of the incident ions reside inside the membranes, *i.e.*  $P_{acc}^{SRIM}$  and  $P_{acc}^{IM3D}$  are over 0.92 and 0.88 when  $E_0 < 20$  keV. The change in  $R_{z|max}$  follows tendencies of the second and third processes when  $E_0 > 25$  keV. In this case,  $P_{acc}$  decreases abruptly from 0.92 to 0.81 ( $P_{acc}^{SRIM}$ ) and from 0.88 to 0.78 ( $P_{acc}^{IM3D}$ ), respectively. Furthermore, the density of  $He^+$  reduces. Thus, more ions are required to reach the dose for nanobubble/bubble cluster nucleation, which is the key to promoting long-range ion-propagation, as stated previously in discussions of figure 4b-e. Thus, we concluded that an  $E_0$  of 20 keV efficiently formed gas bubbles with the combination of intermediate values of  $P_{acc}$ ,  $R_{x,y,z}$ , and  $He^+$  density, resulting in the longest  $R_{z|max}$  in figure 5d.



**Figure 6.** Control of nano-morphology *via* targeted ion irradiation of nanostructures; a nanoscale analogy to blow forming. (a) FHIB irradiation of a nano-pillar with a diameter of 100 nm. This image shows negligible deformation at the top of the pillar due to the absence of the geometric boundary. (b) FHIB irradiation at the boundary between a nano-pillar and its bulk substrate with a point exposure. The bulk substrate side forms a geometric constraint, which enabled deflection of the pillar in the opposite direction. In (a-b), irradiation conditions were 2.4 pA ion current,  $E_0 = 30$  keV and  $D_0 = 8.0 \times 10^6$  ions/point. (c) Cylindrical geometry embedded in flat vertical membrane wall with a line-scan (top: tilt view at  $45^\circ$  and bottom: top view). (d) Asymmetric cylindrical geometry embedded in flat nano-wall with a diagonal line-scan. In (c-d), the irradiation conditions were 2.4 pA ion current,  $E_0 = 35$  keV and  $D_0 = 8.0 \times 10^6$  ions/line. (e) Embedding nano-hemispheres in a micro-disk structure. A 35 keV FHIB was used to irradiate the edge of a micro-disk to form hemispheres at a regular interval. The depth variation with the same  $He^+$  irradiation condition indicates not only the sensitivity of the location of exposed  $He^+$  at the template structure but also the precision of the pre-patterned substrate.

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3 Figure 6 shows advanced control of morphology by targeted He<sup>+</sup> irradiation of nanostructures,  
4 which formed different geometric constraints. In the results described so far, we observed nano-  
5 spherical volume deformation on membrane walls, which is the result of internal gas pressure  
6 balanced by the constraining force of the material surface. Further, we confirmed that this volume  
7 deformation is dependent on  $D_0$ ,  $t_0$ ,  $E_0$ , and location in c-C, implying that we can control the  
8 volume deformation deterministically by controlling these parameters with the help of the  
9 geometric constraint provided by a controlled target. We interpreted our results as a nanoscale  
10 analogy to blow forming<sup>62</sup> induced by helium pressure inside and surrounding existing micro- and  
11 nano-targets.  
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24 Figure 6a shows minimal volume deformation formed in a nanopillar in contrast to the case  
25 when  $t_0 = 100$  nm, which resulted in  $td|_{\max}$  of 230 nm as in figure 5a. This minimal volume  
26 deformation in the nanopillar is due to the absence of geometrical constraint and the high  $P_{esc}^{IM3D}$   
27 of 0.40 in the pillar geometry. Figure 6b shows the use of geometrical constraint by FHIB  
28 irradiation at the boundary between a pillar and a bulk substrate, which acts as the geometrical  
29 constraint. We could deflect the nanopillar in a direction opposite to where  $p_i$  formed at the  
30 boundary. Furthermore, we also formed larger and more complex features in order to show the  
31 nanofabrication capabilities of He<sup>+</sup>-assisted blow forming.  
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42 Figures 6c-d show the results of He<sup>+</sup> irradiation of a membrane with two different line-scan  
43 directions. Figure 6c shows the cylindrical geometry of a nanocavity with uniform volume  
44 deformation in the y-axis along the x-axis. In this case, a geometric constraint formed uniformly  
45 along the x-direction because we fixed the y-position of the FHIB at the centerline of the  
46 membrane. Figure 6d shows an example of using the line-scan in a diagonal direction on top of  
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3 the membrane. As the FHIB moves diagonally, the geometrical constraint changes, resulting in an  
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5 asymmetric cylindrical geometry formed in the membrane.  
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8 Figure 6e shows an example of using the point-exposure in a micro-disk fabricated by  
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10 FGIB. We performed the FHIB irradiation along the edge of the micro-disk of radius  $5.50\ \mu\text{m}$ , but  
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12 with two slightly different radial locations of about  $5.50\ \mu\text{m}$  and  $5.53\ \mu\text{m}$ . The different locations  
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14 effectively formed different geometric constraints due to the limitation of shaping a  $90^\circ$  vertical  
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16 wall based on the Gaussian tail of FGIB. Consequently, the FHIB formed hemispheres in slightly  
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18 different vertical locations. This example shows a novel application of the FHIB to produce  
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20 localized features in large patterns.  
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## 26 **Conclusions**

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28 Targeted ion irradiation of nanostructures has been shown to be an effective method for nanoscale  
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30 modification of materials via a combination of radiation damage, helium implantation, and phase  
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32 transition leading to different material properties in the deformation region. Our method offers the  
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34 unique capabilities of observing site- and nanostructure-specific damage induced by targeted ion  
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36 irradiation. We also present new  $\text{He}^+$ -induced damage in nanostructures of c-C and c-Si that have  
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38 not previously been reported. Specifically, the FHIB irradiation of c-C nanostructures exhibited  
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40 extended damage due to long-range ion propagation and plastic deformation. Our study revealed  
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42 that the extended damage was the result of dynamic changes associated with stopping power, phase  
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44 transition, mass density, bubble nucleation/growth, and helium leakage. We have explained the  
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46 role of material, ion dose, crystal orientation, dimension (thickness), and ion energy in  
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48 nanostructure-specific  $\text{He}^+$ -induced damage using electron microscopy and spectroscopy, and  
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50 Monte Carlo simulations using SRIM and IM3D. Additionally, we have shown radiation damage  
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3 in nanostructures to be influenced by other irradiation conditions, such as ion species, exposure  
4 method, and location. We have also demonstrated the deterministic control of morphologies at the  
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6 nanoscale via targeted He<sup>+</sup> irradiation in existing micro- and nano-structures.  
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10 Although our investigation showed many advantages in the observation of He<sup>+</sup>-induced  
11 morphological changes, a full understanding of He<sup>+</sup> interaction with nanostructures is still limited  
12 by a number of dynamic changes in materials properties. These are dependent on geometry and  
13 difficult to quantitatively predict, such as density of deposited helium and changes in elastic  
14 modulus following amorphization. However, we anticipate that our method and results will enable  
15 new ways to investigate materials physics, locally functionalize materials, and fabricate  
16 nanostructures. Our results can potentially be used to manipulate the hardest material, diamond,  
17 locally for micro- and nano- electromechanical systems.<sup>57</sup>  
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